－Typical Volp（Output Ground Bounce） $<1 \mathrm{~V}$ at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
－High－Drive Outputs（ $-32-\mathrm{mA} \mathrm{I}_{\mathrm{OH}}, 64-\mathrm{mA} \mathrm{I}_{\mathrm{OL}}$ ）
－ $\mathrm{I}_{\text {off }}$ Supports Partial－Power－Down Mode Operation
－Latch－Up Performance Exceeds 500 mA Per JEDEC Standard JESD－17
－ESD Protection Exceeds JESD 22
－2000－V Human－Body Model（A114－A）
－200－V Machine Model（A115－A）

## description

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3－state memory address drivers，clock drivers，and bus－oriented receivers and transmitters．Together with the SN54ABT241， SN74ABT241A，SN54ABT244，and SN74ABT244A，these devices provide the choice of selected combinations of inverting and noninverting outputs，symmetrical active－low output－enable（ $\overline{\mathrm{OE}}$ ）inputs，and complementary OE and $\overline{\mathrm{OE}}$ inputs．
The SN54ABT240 and SN74ABT240A are organized as two 4 －bit buffers／line drivers with separate $\overline{\mathrm{OE}}$ inputs．When $\overline{\mathrm{OE}}$ is low，the devices pass inverted data from the $A$ inputs to the $Y$ outputs．When $\overline{\mathrm{OE}}$ is high，the outputs are in the high－impedance state．

## SN54ABT240 ．．．J OR W PACKAGE

 SN74ABT240A ．．．DB，DW，N，NS，OR PW PACKAGE （TOP VIEW）

SN54ABT240．．．FK PACKAGE （TOP VIEW）


ORDERING INFORMATION

| TA | PACKAGE $\dagger$ |  | ORDERABLE PART NUMBER | TOP－SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | PDIP－N | Tube | SN74ABT240AN | SN74ABT240AN |
|  | SOIC－DW | Tube | SN74ABT240ADW | ABT240A |
|  |  | Tape and reel | SN74ABT240ADWR |  |
|  | SOP－NS | Tape and reel | SN74ABT240ANSR | ABT240A |
|  | SSOP－DB | Tape and reel | SN74ABT240ADBR | AB240A |
|  | TSSOP－PW | Tape and reel | SN74ABT240APWR | AB240A |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP－J | Tube | SNJ54ABT240J | SNJ54ABT240J |
|  | CFP－W | Tube | SNJ54ABT240W | SNJ54ABT240W |
|  | LCCC－FK | Tube | SNJ54ABT240FK | SNJ54ABT240FK |

$\dagger$ Package drawings，standard packing quantities，thermal data，symbolization，and PCB design guidelines are available at www．ti．com／sc／package．

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## SN54ABT240, SN74ABT240A OCTAL BUFFERS/DRIVERS <br> WITH 3-STATE OUTPUTS <br> SCBS098I - JANUARY 1991 - REVISED JUNE 2002

## description (continued)

This device is fully specified for partial-power-down applications using $\mathrm{I}_{\text {off }}$ The $\mathrm{I}_{\text {off }}$ circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.
To ensure the high-impedance state during power up or power down, $\overline{\mathrm{OE}}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| FUNCTION TABLE <br> (each buffer) |  |
| :---: | :---: |
| INPUTS  OUTPUT <br> Y $\overline{\text { OE }}$ A Y <br> L H L <br> L L H <br> H X $Z$ |  |

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$



Voltage range applied to any output in the high-impedance or power-off state, $\mathrm{V}_{\mathrm{O}} \ldots \ldots . . .-0.5 \mathrm{~V}$ to 5.5 V
Current into any output in the low state, IO: SN54ABT240 ........................................... 96 mA SN74ABT240A ........................................... 128 mA


Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): DB package ....................................... $70^{\circ} \mathrm{C} / \mathrm{W}$
DW package ........................................ $58^{\circ} \mathrm{C} / \mathrm{W}$
N package ............................................ $69^{\circ} \mathrm{C} / \mathrm{W}$
NS package ......................................... $60^{\circ} \mathrm{C} / \mathrm{W}$


$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
recommended operating conditions (see Note 3)

|  |  |  | SN54ABT240 |  | SN74ABT240A |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.5 | 5.5 | 4.5 | 5.5 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 2 |  | 2 |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.8 |  | 0.8 | V |
| $\mathrm{V}_{1}$ | Input voltage |  | 0 | $\mathrm{V}_{\mathrm{CC}}$ | 0 | $\mathrm{V}_{\mathrm{CC}}$ | V |
| ${ }^{\mathrm{O}} \mathrm{OH}$ | High-level output current |  |  | -24 |  | -32 | mA |
| IOL | Low-level output current |  |  | 48 |  | 64 | mA |
| $\Delta t / \Delta v$ | Input transition rise or fall rate | Outputs enabled |  | 5 |  | 5 | ns/V |
|  | Operating free-air temperature |  | -55 | 125 | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54ABT240 |  | SN74ABT240A |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP $\dagger$ | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{IK}}$ |  |  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$, | $\mathrm{I}=-18 \mathrm{~mA}$ |  |  | -1.2 |  | -1.2 |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{OH}}$ |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$, | $\mathrm{IOH}=-3 \mathrm{~mA}$ | 2.5 |  |  | 2.5 |  | 2.5 |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, | $\mathrm{IOH}=-3 \mathrm{~mA}$ | 3 |  |  | 3 |  | 3 |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | $\mathrm{IOH}=-24 \mathrm{~mA}$ | 2 |  |  | 2 |  |  |  |  |
|  |  | $\mathrm{I} \mathrm{OH}=-32 \mathrm{~mA}$ | $2^{*}$ |  |  |  |  | 2 |  |  |
| VOL |  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | $\mathrm{IOL}=48 \mathrm{~mA}$ |  |  | 0.55 |  | 0.55 |  |  | V |
|  |  | $\mathrm{l} \mathrm{OL}=64 \mathrm{~mA}$ |  |  |  | 0.55* |  |  |  | 0.55 |  |  |
| $\mathrm{V}_{\text {hys }}$ |  |  |  | 100 |  |  |  |  |  |  | $\overline{\mathrm{mV}}$ |  |
| II |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CC }}$ or GND |  |  | $\pm 1$ |  | $\pm 1$ |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| ${ }^{\text {IOZH }}$ |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$ |  |  | 10 |  | 10 |  | 10 | $\mu \mathrm{A}$ |  |
| IOZL |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  | -10 |  | -10 |  | -10 | $\mu \mathrm{A}$ |  |
| loff |  | V$V_{C C}=0$,$V_{C C}=5.5 \mathrm{~V}, V_{0}=5.5 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{I}}$ or $\mathrm{V}_{\mathrm{O}} \leq 4.5 \mathrm{~V}$ |  |  | $\pm 100$ |  |  |  | $\pm 100$ | $\mu \mathrm{A}$ |  |
| ICEX |  |  | Outputs high |  |  | 50 |  | 50 |  | 50 | $\mu \mathrm{A}$ |  |
| $10^{\ddagger}$ |  | $\mathrm{V}_{C C}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ | -50 | -100 | -180 | -50 | -180 | -50 | -180 | mA |  |
| ${ }^{\text {I CC }}$ |  |  | Outputs high |  | 1 | 250 |  | 250 |  | 250 | $\mu \mathrm{A}$ |  |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \mathrm{I}_{\mathrm{O}}=0, \\ & \mathrm{~V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} \end{aligned}$ | Outputs low |  | 24 | 30 |  | 30 |  | 30 |  |  |
|  |  | Outputs disabled |  | 0.5 | 250 |  | 250 |  | 250 | $\mu \mathrm{A}$ |  |  |
| $\Delta^{\prime} \mathrm{CC}$ § | Data inputs |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, <br> One input at 3.4 V , <br> Other inputs at $V_{C C}$ or GND | Outputs enabled |  |  | 1.5 |  | 1.5 |  | 1.5 | mA |
|  |  | Outputs disabled |  |  |  | 0.05 |  | 0.05 |  | 0.05 |  |  |
|  | Control inputs | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$, One input at 3.4 V , Other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND |  |  |  | 1.5 |  | 1.5 |  | 1.5 |  |  |
| $\mathrm{C}_{\mathrm{i}}$ |  |  |  | 4 |  |  |  |  |  |  | pF |  |
| $\mathrm{C}_{0}$ |  |   <br> V $=2.5 \mathrm{~V}$ or 0.5 V <br> V  <br> O $=2.5 \mathrm{~V}$ or 0.5 V |  | 7.5 |  |  |  |  |  |  | pF |  |

[^0]switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ABT240 |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | MIN | MAX |  |
|  |  |  | MIN | TYP | MAX |  |  |  |
| tPLH | A | Y | 1 | 2.9 | 4.3 | 0.8 | 5.5 | ns |
| tPHL |  |  | 1.6 | 3.1 | 4.5 | 1 | 5.5 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Y | 1.1 | 3.1 | 5.8 | 0.8 | 7.5 | ns |
| tPZL |  |  | 1.1 | 2.7 | 6.2 | 0.8 | 7.7 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | Y | 1.8 | 4.6 | 5.9 | 1.7 | 7 | ns |
| tPLZ |  |  | 1.6 | 4 | 5.9 | 1.3 | 7.2 |  |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN74ABT240A |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | MIN | MAX |  |
|  |  |  | MIN | TYP | MAX |  |  |  |
| tPLH | A | Y | 1 | 2.9 | 4.1 | 1 | 4.8 | ns |
| tPHL |  |  | 1.6 | 3.1 | 4.6 | 1.6 | 4.8 |  |
| tPZH | $\overline{O E}$ | Y | 1.1 | 3.1 | 4.7 | 1.1 | 5.2 | ns |
| tPZL |  |  | 1.1 | 2.7 | 5.8 | 1.1 | 6.2 |  |
| tPHZ | $\overline{O E}$ | Y | 1.8 | 4.6 | 5.7 | 1.8 | 6.4 | ns |
| tplZ |  |  | 1.6 | 4 | 5.4 | 1.6 | 5.8 |  |

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | $\text { Eco Plan }{ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5962-9318801M2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| 5962-9318801MRA | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 SNPB | N/ A for Pkg Type |
| 5962-9318801MSA | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N/ A for Pkg Type |
| SN74ABT240ADBLE | OBSOLETE | SSOP | DB | 20 |  | TBD | Call TI | Call TI |
| SN74ABT240ADBR | ACTIVE | SSOP | DB | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ADBRG4 | ACTIVE | SSOP | DB | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ADW | ACTIVE | SOIC | DW | 20 | 25 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ADWE4 | ACTIVE | SOIC | DW | 20 | 25 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ADWR | ACTIVE | SOIC | DW | 20 | 2000 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ADWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240AN | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74ABT240ANE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74ABT240ANSR | ACTIVE | SO | NS | 20 | 2000 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240ANSRE4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240APW | ACTIVE | TSSOP | PW | 20 | 70 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240APWE4 | ACTIVE | TSSOP | PW | 20 | 70 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240APWLE | OBSOLETE | TSSOP | PW | 20 |  | TBD | Call TI | Call TI |
| SN74ABT240APWR | ACTIVE | TSSOP | PW | 20 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT240APWRE4 | ACTIVE | TSSOP | PW | 20 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ54ABT240FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54ABT240J | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SNJ54ABT240W | ACTIVE | CFP | W | 20 | 1 | TBD | A42 | N/ A for Pkg Type |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[^1]PACKAGE OPTION ADDENDUM
at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J ( $\mathrm{R}-\mathrm{GDIP}-\mathrm{T} * *$ )
CERAMIC DUAL IN-LINE PACKAGE
14 LEADS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)
CERAMIC DUAL FLATPACK


4040180-4/D 07/03
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length ( $\operatorname{Dim} A$ ).
(D) The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)
PLASTIC SMALL-OUTLINE PACKAGE


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AC.

## MECHANICAL DATA

NS (R-PDSO-G**)
PLASTIC SMALL-OUTLINE PACKAGE
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 .

DB (R-PDSO-G**)
28 PINS SHOWN


| DIM PINS ** | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ | $\mathbf{3 0}$ | $\mathbf{3 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 6,50 | 6,50 | 7,50 | 8,50 | 10,50 | 10,50 | 12,90 |
| A MIN | 5,90 | 5,90 | 6,90 | 7,90 | 9,90 | 9,90 | 12,30 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-150


| PIM PINS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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[^0]:    * On products compliant to MIL-PRF-38535, this parameter does not apply.
    $\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$.
    $\ddagger$ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
    $\S$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{C C}$ or GND.

[^1]:    ${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
    TBD: The Pb-Free/Green conversion plan has not been defined.
    Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered

